

Diode

Rapid Switching Emitter Controlled Diode

IDP30C65D2

Emitter Controlled Diode Rapid 2 Common Cathode Series

Data sheet

Industrial Power Control

Rapid Switching Emitter Controlled Diode

Features:

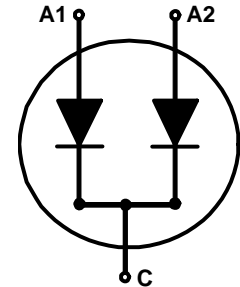
- Qualified according to JEDEC for target applications
- 650 V Emitter Controlled technology
- Fast recovery
- Soft switching
- Low reverse recovery charge
- Low forward voltage and stable over temperature
- 175 °C junction operating temperature
- Easy paralleling
- Pb-free lead plating; RoHS compliant

Applications:

- Boost diode in CCM PFC

Package pin definition:

- Pin 1 - anode (A1)
- Pin 2 and backside - cathode (C)
- Pin 3 - anode (A2)



Key Performance and Package Parameters

Type	V_{rrm}	I_f	$V_f, T_{vj}=25^{\circ}\text{C}$	T_{vjmax}	Marking	Package
IDP30C65D2	650V	2x 15A	1.6V	175°C	C30ED2	PG-TO220-3



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Maximum Ratings (electrical parameters per diode)

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage, $T_{vj} \geq 25^{\circ}\text{C}$	V_{RRM}	650	V
Diode forward current, limited by T_{vjmax} $T_C = 25^{\circ}\text{C}$ $T_C = 100^{\circ}\text{C}$	I_F	30.0 15.0	A
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpuls}	45.0	A
Diode surge non repetitive forward current $T_C = 25^{\circ}\text{C}$, $t_p = 8.3\text{ms}$, sine halfwave	I_{FSM}	100.0	A
Power dissipation $T_C = 25^{\circ}\text{C}$	P_{tot}	92.0	W
Operating junction temperature	T_{vj}	-40...+175	$^{\circ}\text{C}$
Storage temperature	T_{stg}	-55...+150	$^{\circ}\text{C}$
Soldering temperature, wave soldering 1.6 mm (0.063 in.) from case for 10s		260	$^{\circ}\text{C}$
Mounting torque, M3 screw Maximum of mounting processes: 3	M	0.6	Nm

Thermal Resistances (per diode)

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
Diode thermal resistance, ¹⁾ junction - case	$R_{th(j-c)}$		1.63	K/W
Thermal resistance junction - ambient	$R_{th(j-a)}$		62	K/W

Electrical Characteristics (per diode), at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Static Characteristic						
Diode forward voltage	V_F	$I_F = 15.0\text{A}$ $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	- -	1.60 1.65	2.20 -	V
Reverse leakage current ²⁾	I_R	$V_R = 650\text{V}$ $T_{vj} = 25^{\circ}\text{C}$ $T_{vj} = 175^{\circ}\text{C}$	- -	4.0 400.0	40.0 -	μA

Electrical Characteristic, at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Dynamic Characteristic						
Internal emitter inductance measured 5mm (0.197 in.) from case	L_E		-	7.0	-	nH

¹⁾ Please be aware that in non standard load conditions, due to high $R_{th(j-c)}$, T_{vj} close to T_{vjmax} can be reached.

²⁾ Reverse leakage current per diode specified for operating conditions with zero voltage applied to the other diode.

Switching Characteristics (per diode), Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Diode Characteristic, at $T_{vj} = 25^{\circ}\text{C}$						
Diode reverse recovery time	t_{rr}	$T_{vj} = 25^{\circ}\text{C}$, $V_R = 400\text{V}$, $I_F = 15.0\text{A}$, $di_F/dt = 1000\text{A}/\mu\text{s}$, $L\sigma = 30\text{nH}$, $C\sigma = 40\text{pF}$, switch IKW50N65H5	-	31	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.20	-	μC
Diode peak reverse recovery current	I_{rrm}		-	10.1	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-850	-	$\text{A}/\mu\text{s}$
Diode reverse recovery time	t_{rr}	$T_{vj} = 25^{\circ}\text{C}$, $V_R = 400\text{V}$, $I_F = 15.0\text{A}$, $di_F/dt = 400\text{A}/\mu\text{s}$, $L\sigma = 30\text{nH}$, $C\sigma = 40\text{pF}$, switch IKW50N65H5	-	42	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.16	-	μC
Diode peak reverse recovery current	I_{rrm}		-	5.4	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-250	-	$\text{A}/\mu\text{s}$

Switching Characteristics (per diode), Inductive Load

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
Diode Characteristic, at $T_{vj} = 175^{\circ}\text{C}/125^{\circ}\text{C}$						
Diode reverse recovery time	t_{rr}	$T_{vj} = 175^{\circ}\text{C}$, $V_R = 400\text{V}$, $I_F = 15.0\text{A}$, $di_F/dt = 1000\text{A}/\mu\text{s}$, $L\sigma = 30\text{nH}$, $C\sigma = 40\text{pF}$, switch IKW50N65H5	-	32	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.29	-	μC
Diode peak reverse recovery current	I_{rrm}		-	11.5	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-800	-	$\text{A}/\mu\text{s}$
Diode reverse recovery time	t_{rr}	$T_{vj} = 125^{\circ}\text{C}$, $V_R = 400\text{V}$, $I_F = 15.0\text{A}$, $di_F/dt = 400\text{A}/\mu\text{s}$, $L\sigma = 30\text{nH}$, $C\sigma = 40\text{pF}$, switch IKW50N65H5	-	42	-	ns
Diode reverse recovery charge	Q_{rr}		-	0.22	-	μC
Diode peak reverse recovery current	I_{rrm}		-	6.0	-	A
Diode peak rate of fall of reverse recovery current during t_b	di_{rr}/dt		-	-400	-	$\text{A}/\mu\text{s}$

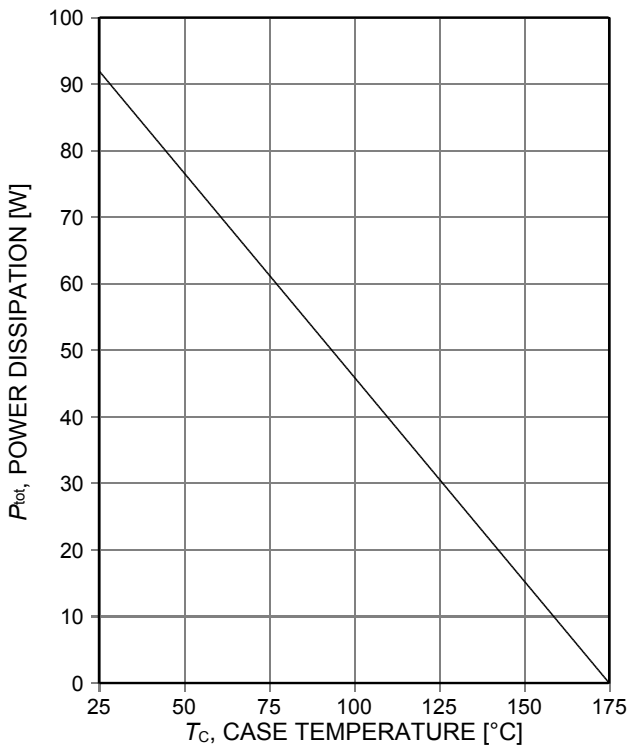


Figure 1. Power dissipation per diode as a function of case temperature ($T_{vj} \leq 175^\circ\text{C}$)

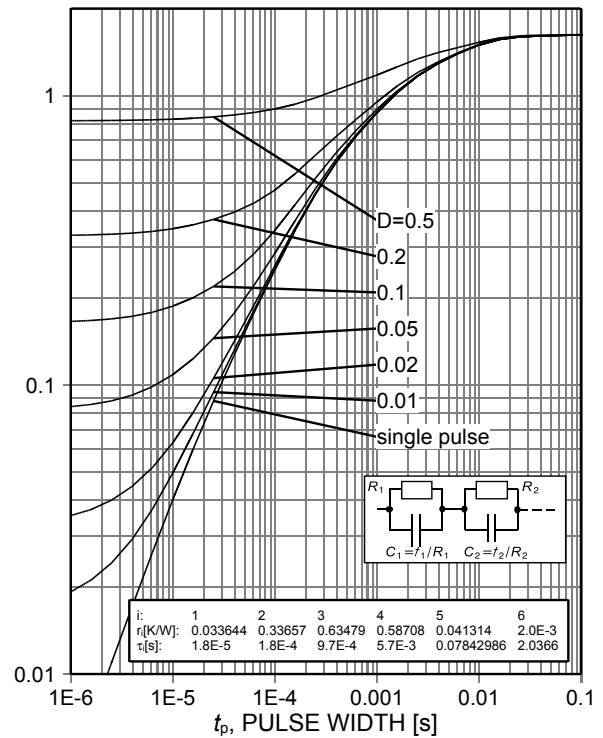


Figure 2. Diode transient thermal impedance per diode as a function of pulse width ($D = t_p/T$)

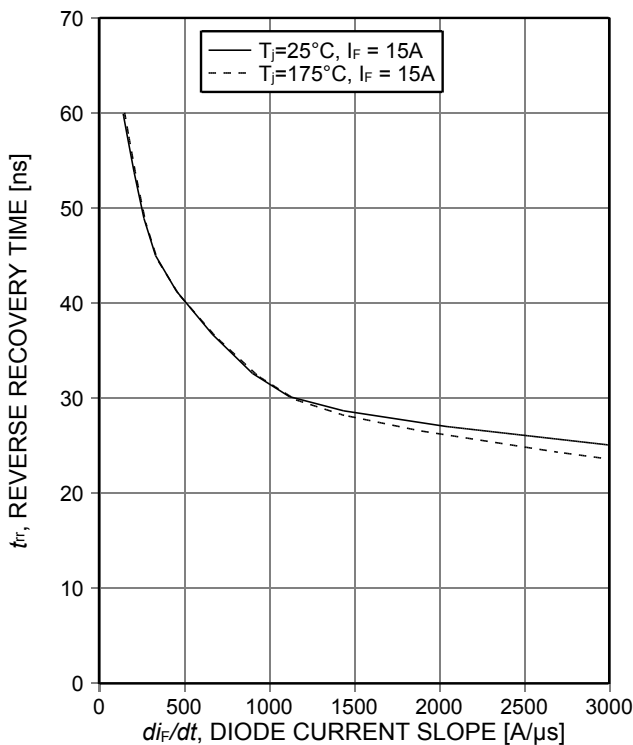


Figure 3. Typical reverse recovery time as a function of diode current slope ($V_R=400\text{V}$)

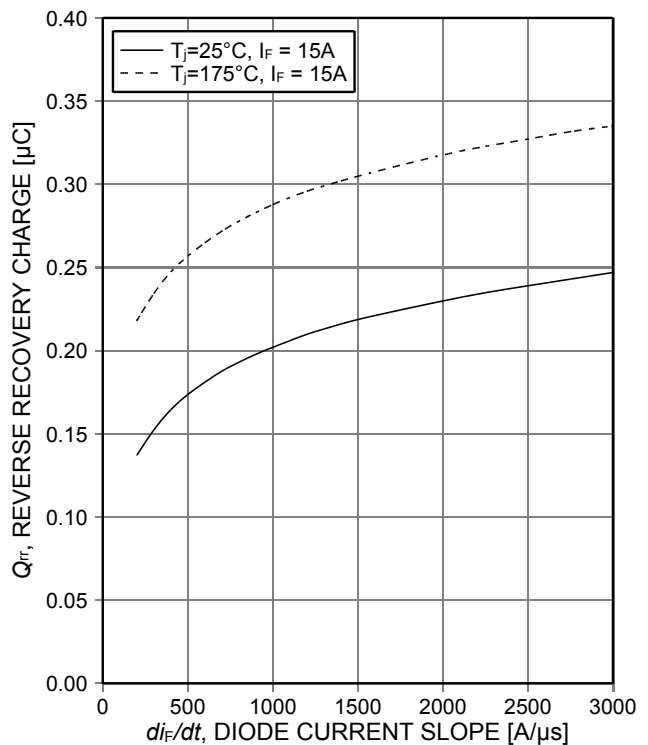


Figure 4. Typical reverse recovery charge per diode as a function of diode current slope ($V_R=400\text{V}$)

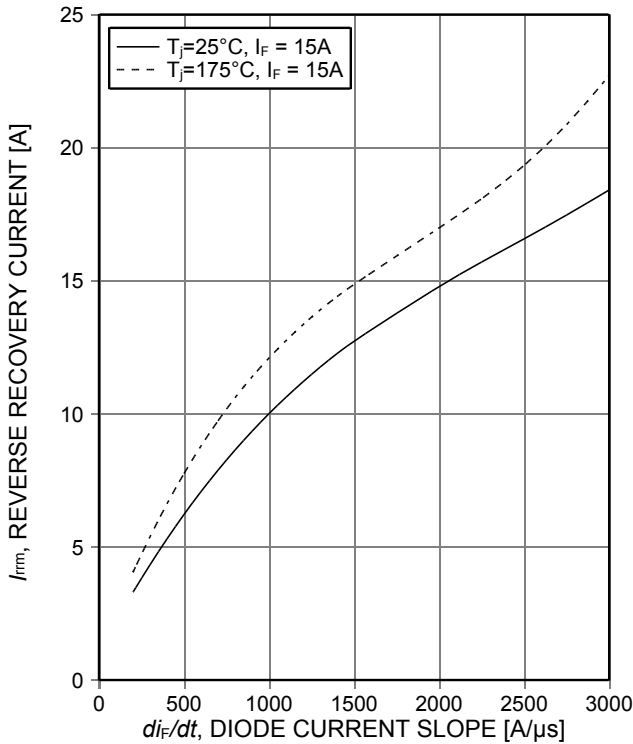


Figure 5. Typical peak reverse recovery current per diode as a function of diode current slope ($V_R=400V$)

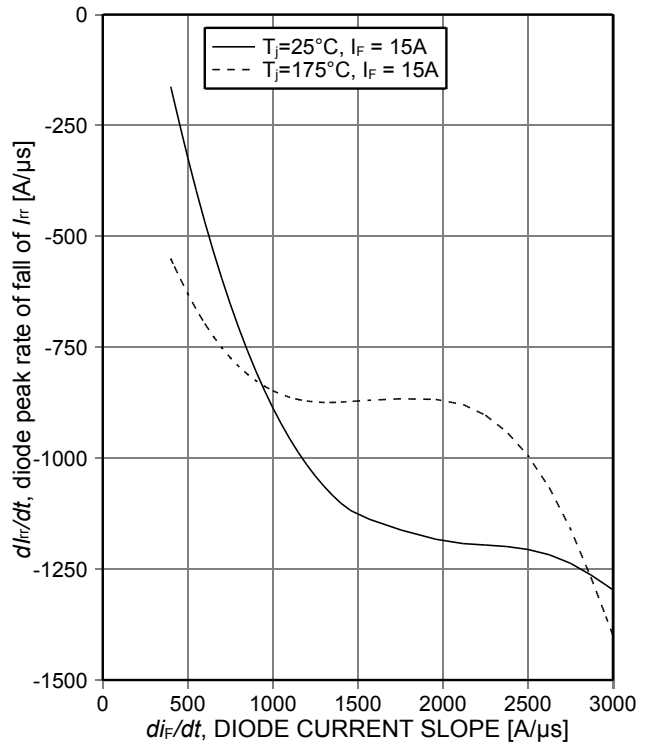


Figure 6. Typical diode peak rate of fall of rev. rec. current per diode as a function of diode current slope ($V_R=400V$)

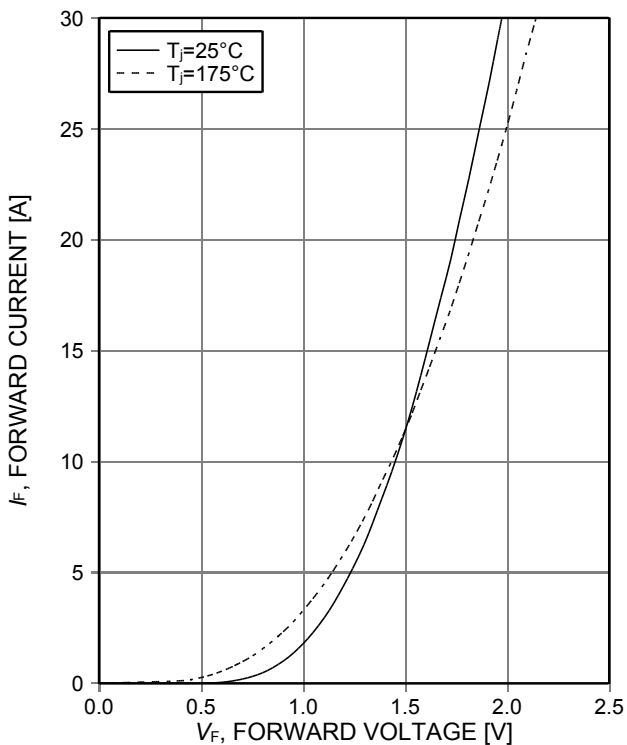


Figure 7. Typical diode forward current per diode as a function of forward voltage

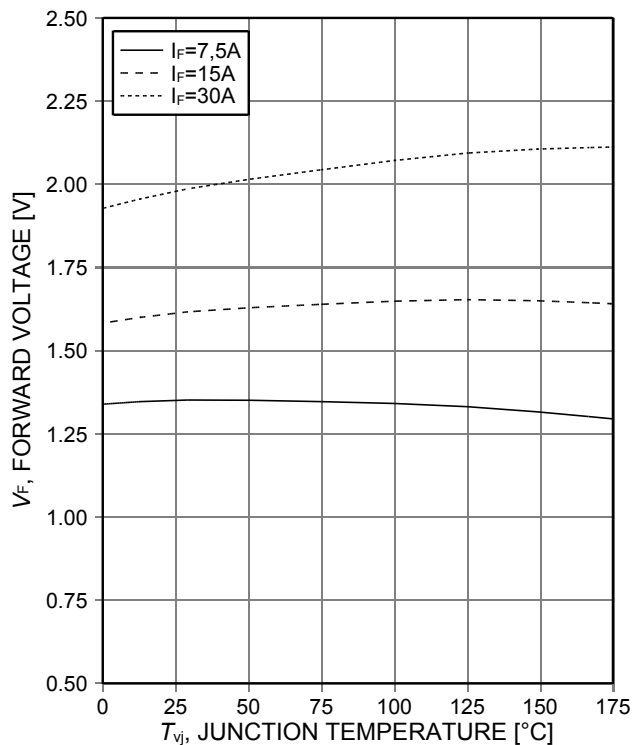
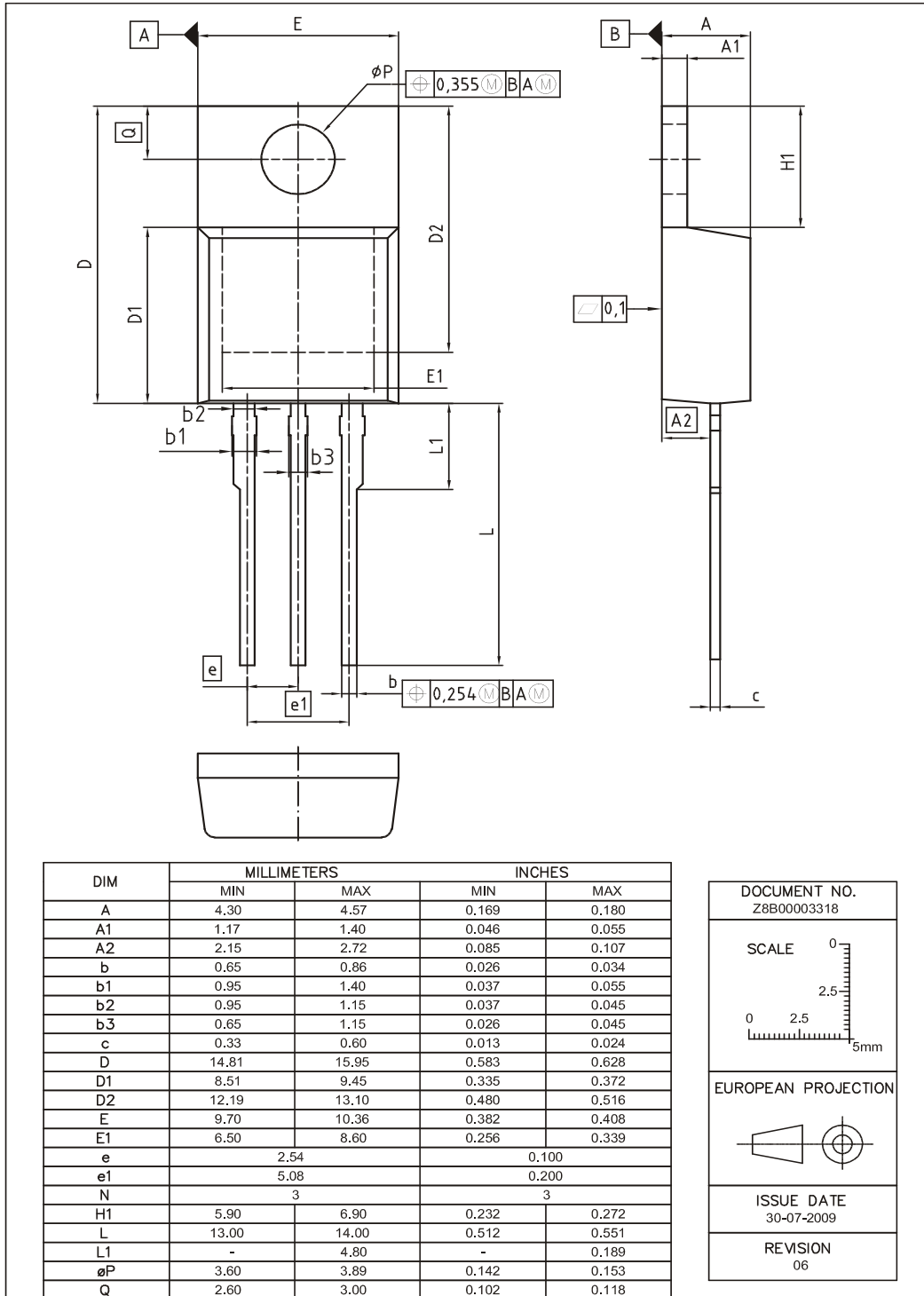


Figure 8. Typical diode forward voltage as a function of junction temperature

PG-TO220-3



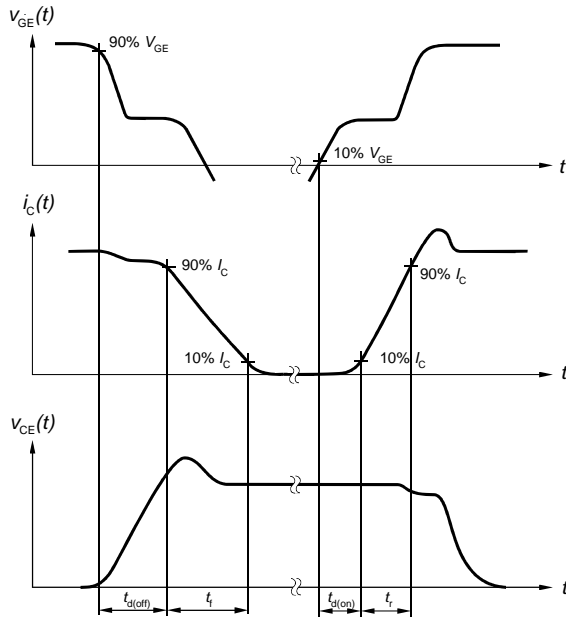


Figure A. Definition of switching times

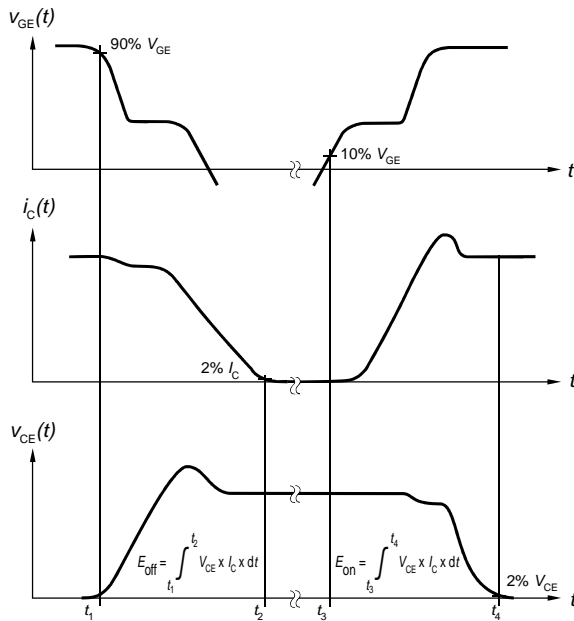


Figure B. Definition of switching losses

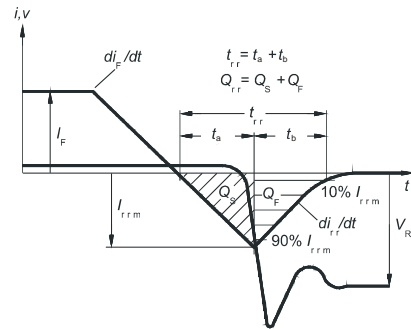


Figure C. Definition of diodes switching characteristics

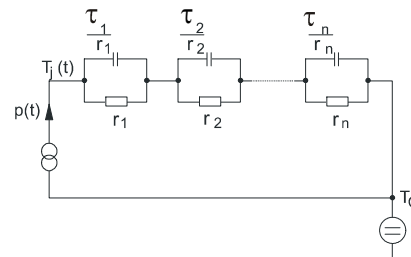


Figure D. Thermal equivalent circuit

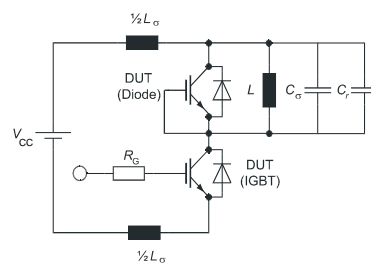


Figure E. Dynamic test circuit
Parasitic inductance L_σ ,
Parasitic capacitor C_σ ,
Relief capacitor C_r
(only for ZVT switching)

Revision History

IDP30C65D2

Revision: 2014-09-18, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.1	2014-09-18	Final data sheet

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